Infineon drive systems solutions

Explore Infineon's variety of innovative power semiconductors which enable designers to develop highly reliable and efficient solutions for all kinds of drive applications.



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5.0 Wireless charging

1.0 Introduction

We live in a mobile world filled with electrical devices. From the mobile phone in our pocket to the new EV car in our garage, our environment is becoming more and more automated and power hungry by the day. Innovations in consumer-grade robots are giving us robots that can mow our lawns or clean our homes. Highly efficient electric motors are replacing the traditional motors in home appliances, automobiles, and industry. The demand for light electric vehicles such as e-scooters and pedelecs is increasing exponentially. Multicopter technology is evolving at an incredible pace. Behind all of this innovation, a wireless charging revolution is changing how we power these devices and motors that surround us.

As these products evolve and improve, there is an increasing need for designers and engineers to find solutions that are more efficient, smaller, and less costly than ever before. Infineon's broad portfolio of semiconductor solutions including MOSFETs, drivers, microcontrollers, sensors, intelligent power modules, transistors, and security are exactly what is needed for the compact, cost effective designs of today, and for the innovative designs of tomorrow.



19 20 21 22 23 23 24

2.0 Battery powered drives

Superb performance for battery powered motor drives

Infineon's wide variety of high quality state-of-the-art high quality power semiconductors are built upon industry-leading technologies and manufacturing expertise. The comprehensive portfolio of power semiconductors enables engineers and designers to develop highly reliable and efficient solutions for a wide range of battery powered motor drive applications such as multicopters, service robotics, power tools, forklifts, and various light electric vehicles including e-skateboards, e-scooters, pedelecs, and low speed cars.

Infineon offers an excellent selection of devices for power management and power consumption, as well as voltage regulation – such as power MOSFETs (e.g. OptiMOS[™] and CoolMOS[™]), XMC[™] microcontrollers, gate driver ICs and more. To find the right fit for your application, take a look at Infineon's solution matrix!



¹⁾ If the necessary package/R_{DSion} combination is not available in the new CoolMOSTM P7 series yet, the previous CoolMOSTM CE and P6 series are the preferred series

2.1 Consumer robotics

The fastest growing segment of the whole robotics market

2.1.1 Multicopters

Cost-effective system solutions

One of the largest growth segments of the consumer robotics marketplace is in multicopters. Core multicopter features such as camera applications, autonomous flight, and sophisticated on-board equipment is pushing the limits of performance, efficiency, and control. From XMC[™] microcontrollers and iMOTION[™] motor control ICs to magnetic sensors, Infineon offers a comprehensive system solution portfolio of high quality products well suited for multicopter designs.

Application example block diagram - multicopter





Solution tree for multicopters



2.1.2 Service robotics

Powerful and quiet solutions

Service robotics is a high growth market segment with an estimated 15 percent compound annual growth rate within the next 5 years. The primary focus of this growth is in two key areas, electric vacuum cleaners and lawn mowers. High performance Infineon components such as low R_{DS(on)} MOSFETs, powerful microcontrollers, and sensors can be used to develop solutions with high power density, reduced weight, and low noise.

Application example block diagram - service robotics

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Solution tree for service robotics (vacuum cleaners and lawn mowers)

	Cha	arger					Motor control		
High voltage MOSFETs		PF	с	М	icrocontrollers		Sensors		Gate driver ICs
 > 500 V-600 V CoolMOS™ CE > 600 V-700 V CoolMOS™ P7 (standard grade) 		> CoolSET™		> XMC1000 > XMC4000		> Hall switche	es TLE496X	 > EiceDRIVER" - 6EDL04N0: - 2EDL05N0i - 2ED2304S0 > Gate driver I Integrated - IFX9201SG - BTN8982 	 200 V and 600 V 2PR gate driver 3PF – IRS2005S/M 3PF – IRS2007S Cs / – IRS2008S - IRS2001 - IRS21867 - IRS2334
				Battery m	anagement				
Sensors		Microcontrollers/ driver supplies	High voltage MOS	SFETs	Low voltage MO	SFETs	Gate driver I	Cs	Authentications ICs
 > Hall switches TLI496X > Angle sensor TLI5012B > 3D Magnetic sensor TLV493D 	 XMC1300 IFX1763 IFX54441 IFX54211 IFX21003 IFX30081 IFX30081 IFX90121 IFX91041 		 > 500 V-650 V CoolMOS[™] CE > 600 V CoolMOS[™] P7 (stand 	<u>-</u> dard grade)	 > OptiMOS[™] 25 V-200 V in DPAK, DirectFET[™], D²PAI PQFN 3x3, TO-220 > StrongIRFET[™] 20 V-200 V in SuperSO8, DPAK, Dire D²PAK, PQFN 3x3, TO-22 	SuperSO8, <, / ctFET™, 0	 > EiceDRIVER™ - 6EDL04N02PR - 2EDL05N06PF - 2ED2304S06F > 200 V and 600 V gate driv - IRS2005S/M - IRS2007S - IRS2007S - IRS2001 - IRS21867 - IRS2334 	/er	> OPTIGA™ Trust B

2.2 Home and professional use

Highest power density and system efficiency

Cordless power tools are major part of the rapidly growing electric tool market. The convenience and safety of lightweight and low-voltage cordless power tools benefits both professional and private users. Depending on the topology, cordless power tools require either space-optimized designs or cost-optimized solutions. Infineon offers a complete portfolio of reliable, high performance MOSFETs, drivers, microcontrollers, and sensors which can be used for both space and cost optimized designs.

Application example block diagram - power tool





Solution tree for power tools

Charger			Motor control					
High voltage MOSFETs		PFC	Mi	icrocontrollers		Sensors		Gate driver ICs
 > 500 V-600 V CoolMOS™ CE > 600 V-700 V CoolMOS™ P7 (standard grade) 	> CoolSET™		> XMC1000 > XMC4000		> Hall switche	es TLE496X	 > EiceDRIVER™ - 6EDL04N02P - 2EDL05N06P - 2ED2304S06F > Gate driver ICs Integrated - IFX9201SG - BTN8982 	 > 200 V and 600 V R gate driver F - IRS2005S/M F - IRS2007S / - IRS2008S - IRS2301 - IRS21867 - IRS2334
			Battery m	anagement				
Sensors	Microcontrollers/ driver supplies	High voltage M	OSFETs	Low voltage MO	SFETs	Gate drive	rICs	Authentications ICs
> Hall switches TLI496X	 > XMC1300 > IFX1763 > IFX54441 > IFX54211 > IFX21003 > IFX30081 > IFX90121 > IFX91041 	 > 500 V-650 V CoolMOS™ > 600 V CoolMOS™ P7 (st. 	CE andard grade)	 > OptiMOS[™] 25 V-200 V in DPAK, DirectFET[™], D²PAI PQFN 3x3, TO-220 > StrongIRFET[™] 20 V-200 \ SuperSO8, DPAK, DirectI D²PAK, PQFN 3x3, TO-22 D²PAK 7pin+ 	SuperSO8, K, Vin FET™, 0,	 > EiceDRIVER[™] 1EDN 2EDN 6EDL04N02PR 2ED2304S06F > 200 V and 600 V gate driver IRS2005S/M IRS2007S IRS2007S IRS2031 IRS21867 IRS2334 	>	OPTIGA™ Trust B

2.3 Light electric vehicles

Performance leadership and system solution

The need to reduce pollution in urban areas as part of improving our environment has resulted in a shift towards alternative means of transportation. The rise in popularity of e-mobility products such as e-bikes, e-scooters, and low speed electric cars has exposed the need for more efficient and higher performing electric motors. The efficiency and high performance must also be supported by increased battery life, operating range, and reduced charging time. With XMC[™] microcontrollers, EiceDRIVER[™] gate drivers and OptiMOS[™] low voltage MOSFETs, Infineon provides solutions for all e-mobility applications.







Solution tree for light electric vehicles

Charger			Motor control				
High voltage MOSFETs		PFC		Microcontrollers		Sensors	Gate driver ICs
> 600 V CooMOS™ P7 (industrial grade)	 > CoolSET™ > EiceDRIVER™ 1E > EiceDRIVER™ 2E 	DN DN	<pre>> XMC1300 > XMC4400 > XMC4500</pre>		> Hall sw	vitches TLE496X	 > EiceDRIVER™ - 6EDL04N02PR - 2EDL05N06PF - 2ED2304S06F > 200 V and 600 V gate driver - IRS2005S/M - IRS2007S - IRS2008S - IRS2127 - IRS2136
			Battery m	anagement			
Sensors	Microcontrollers/ driver supplies	High voltage MC	OSFETs	Low voltage MOSFETs		Gate driver ICs	Authentications ICs
 Hall switches TLI496X Angle sensor TLI5012B 	<pre>> XMC1300 > XMC4400 > XMC4500 > IFX1763 > IFX54441 > IFX54211 > IFX54211 > IFX30081 > IFX91021 > IFX91041</pre>	> 600 V CooMOS™ P7 (industrial grade)		 > OptiMOS[™] 60 V-300 V in DPAK, D²PAK 7pin, TOLL, TO-220 > StrongIRFET[™] 60 V-200 V in DPAK, D²PAK , D²PAK 7pin+, 1 	ГО-220	 > EiceDRIVER™ 1EDN 2EDN 6EDL04N02PR 2EDL05N06PF 2ED2304S06F > 200 V and 600 V gate driver IRS2005S/M IRS2008S IRS2127 IRS2136 	> OPTIGA [™] Trust B

3.0 Home and building automation

Once merely a vision, the smart home gain traction on an ever larger scale, home and building automation designs gets a whole new dimension. Motorized retractable shades, panels, projector screens, and door openers etc. are all sub-applications in the field of home and building automation. In the specific terms of security and the harsh exterior environment, including temperature extremes and humidity, present design challenges. Nevertheless reliability, robustness together with cost-effectiveness retain the leading parts in home automation solutions. As a proven leader in this field, Infineon's competence paired with a portfolio of high-quality components (CIPOS[™] family) for home automation technology can help in a range of home systems

Like in most consumer and home applications, slick design, compact, reliable and efficient are key end-product features. These features translate to thin, small, integrated modules that provide higher efficiency, reliability and hardware protection. The CIPOS[™] family provides such solutions in varying form factor and power applications of motor, drive, pump, and plunger.

3.1 CIPOS[™] family

Control integrated power system- intelligent power modules (CIPOS[™] IPMs) are a family of highly integrated, compact power modules designed into drive motors for applications ranging from building automation, home appliances, to fans, pumps and general purpose drives. Depending on the level of integration and power to be handled, Infineon offers a range of IPMs available in different packages and diverse voltage and current classes. These IPM portfolios include CIPOS[™] Nano, CIPOS[™] Micro and CIPOS[™] Mini families.





3.1.1 CIPOS[™] Nano

3-phase or half-bridge with MOSFETs

CIPOS[™] Nano is a family of ultra-compact, power modules for high efficiency and light industrial applications, including compressor drives for automation systems. By utilizing an innovative packaging solution, the CIPOS[™] Nano family delivers a new benchmark in package size, offering up to a 60 percent smaller footprint compared to existing 3-phase motor control power IPMs and even eliminating the need for an external heat sink.

Selected CIPOS[™] Nano products

Product	Voltage class [V]	R _{DS (on)} (25°C) max. [Ω]	P _{mot} (10 kHz) [W]	Built in NTC	Configuration	Package	
	3-phase						
IRSM836-045MA	500	1.7	80	no	3-phase open source	PQFN 12x12	
IRSM836-084MA	250	0.45	85	no	3-phase open source	PQFN 12x12	
Half-bridge							
IRSM807-045MH	500	1.7	130	no	Half-bridge	PQFN 8x9	



Application example for brushed DC motor drive



3.1.2 CIPOS[™] Micro

High performance solution for home and building automation motor drives

CIPOS[™] Micro is a family of compact and efficient intelligent power modules (IPMs) for motor drives. Micro IPMs are the best choice for various drives used in motorized window blinds, shades, shutters, automatic curtain drawing systems, door openers and other applications. Wide range of voltage, current ratings and features helps the designer in making optimum IPM selection for various motor power and application conditions. They offer DC current ratings ranging up to 4.6 A to drive motors up to 90 W without heatsink and up to 250 W with heatsink. CIPOS[™] Micro family products are available in both through-hole and surface mount packages.

Selected CIPOS[™] Micro products

1 2

Product	Voltage class [V]	Rated current [A]	P _{mot} (10 kHz) [W]	Built in NTC	Configuration	Package
IRSM506-076DA	600	4	105	yes	3-phase open source	DIP23
IRSM506-076PA	600	4	105	yes	3-phase open source	SOP23
IRSM516-076DA	600	4	105	no	3-phase open source	DIP23
IRSM516-076PA	600	4	105	no	3-phase open source	SOP23

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Application example for brushless DC motor control and drives



3.1.3 CIPOS™ Mini

Broad range of application from PFC to inverter

CIPOS[™] Mini modules integrate various power and control components to increase reliability, and to optimize PCB size and system costs. This simplifies the power design and reduces significantly time-to-market. These modules are designed to control AC motors in variable speed drives for applications from 4 A up to 30 A such as air conditioning, washing machines, refrigerators, vacuum cleaners, compressors and industrial drives.

Selected CIPOS[™] Mini products

Product	Package	Voltage class [V]	P _{mot} (10 kHz) [W]	Rated current [A]			
	3-phase open emitter						
IKCM10L60GA	MDIP-24 Fullpack	600	1200	10			
IKCM10L60HA	MDIP-24 Fullpack	600	1200	10			
IKCM15L60GA	MDIP-24 Fullpack	600	1600	15			
IKCM15L60HA	MDIP-24 Fullpack	600	1600	15			



4.0 Motor control and drives

Nowadays motors are increasingly driven via electronics systems, which offer more precise control of speed, position, and torque, as well as higher efficiency, rather than via direct connection to their source of power. The motor control circuit has to control the current flowing in the motor's coils in the most efficient way. Leading semiconductor solutions from Infineon's wide portfolio offers high product quality and reliability, industry leading highly efficient technology and competitive price.

4.1 Industrial drives (IGBT discrete)

4.1.1 Automation, axis control and industrial robots

Applications like rotary printing press, textile machines, bottling plants, CNC machinery, automated manufacturing or industrial robotics require high-quality motors capable of top energy efficiency and reliable performance. Most common motor types used are DC-induction- and servo motors. Servo motors–more precisely called permanent magnet synchronous machines or referred to as brushless DC-motors offer higher torque/volume ratio and lower inertia, thus allow higher dynamics. A servo motor is often equipped with a sensor which gives feedback about the position. As a rotary actuator, it enables precise control of the position, velocity and acceleration. A unique characteristic of the servo motor is that it consumes power while rotating to the desired position and then rests upon arrival.

Application example for servo motor control and drives







4.1.2 Industrial power machines

Industrial power machines cover applications like forming machines, punching tools, cranes, conveyors, belts. The most common motor topologies for are induction motor, DC motor and brushless DC motor. Today growing numbers of applications rely on brushless DC (BLDC) motor. In each instance BLDC motor is chosen for its numerous advantages, such as highest efficiency, smaller motor size, light weight, longer lifetime and low cost of maintenance. Infineon's product offer for industrial power tools provides a wide product portfolio ranging from power switches to microcontrollers, dedicated motor control ICs, gate drivers and sensors to enable customers to design a more efficient brushless DC motor driven application.

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Application example for brushless DC motor (discrete)





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 Battery DC-DC
 Inverter
 Gate driver

 1200 V TRENCHSTOP™ IGBT
 15 A, 25 A, 40 A, 50 A, 75 A IGBT+diode
 in TO-247-3, TO-247PLUS-3

 600 V TRENCHSTOP™ IGBT
 600 V TRENCHSTOP™ IGBT
 600 V TRENCHSTOP™

 9erformance IGBT
 6 A-120 A IGBT+diode in DPAK,

D²PAK, TO-220, TO-220 FullPAK, TO-247-3, TO-247PLUS3

4.2 Industrial drives (module)

Electrical drive systems play a key role in energy savings. They account for two-thirds of electrical energy consumed in industry and they are a central component of automation systems. There are two distinct industrial drive technology groups. The first group includes electrically driven machines requiring position control. This group includes, for example, machine tools, measuring machines and packaging machines where precision in movement is required. The second group covers all applications where a fluid is moved by pumps and fans. Here variable speed drives allow the flow to be aligned with the needs of the process. Compared with traditional methods of flow control like throttling and bypassing, electronic speed control significantly increases overall efficiency. Furthermore, an inverter enables more efficient motor technologies, like permanent magnet synchronous motors and reluctance motors, to be used. Today, these drives can be implemented in a power range from watts up to megawatts.

Nearly all static converters for electrical drives used today employ a combination of input rectifier, DC link and output inverter. If no regeneration system is required for the electrical drive, the most competitive semiconductor components for the input rectifier are bipolar thyristors and/or diodes offered in various topologies, such as complete 6-pack modules, half-bridge modules or single modules. In high-power electrical drives, the input rectifier consists of thyristors and/or diodes in Presspack housings. If regeneration is required, an active front end can be designed using IGBT modules. In the low-power range, where power factor correction is mandatory in some applications, PFC (power factor correction) circuits can be designed using discrete IGBTs and diodes or dedicated modules. Infineon provides the latest chip technology embedded into innovative mechanical module designs. This enables our customers to develop highly reliable and efficient solutions. The Easy family was developed to offer a cost-efficient, compact design. These modules are an optimized product generation for low- and medium-power industrial drives.



4.2.1 Easy family

With EasyPIM[™] and EasyPACK[™] configurations, the Easy family portfolio covers the full power range from 10 A up to 50 A in 600 V with IGBT3. This series comes in the Easy1B and Easy2B housing. The screw clamp provides a fast, reliable mounting concept.

Selected EasyPIM[™] 3-phase products - 600 V

Product	Package	Pin	Description
FP50R06W2E3	EasyPIM [™] 2B	Solder contact	PIM 3-phase input rectifier
FP50R06W2E3_B11	EasyPIM [™] 2B	PressFIT	PIM 3-phase input rectifier
FP30R06W1E3	EasyPIM™ 1B	Solder contact	PIM 3-phase input rectifier
FP30R06W1E3_B11	EasyPIM [™] 1B	PressFIT	PIM 3-phase input rectifier
FP20R06W1E3	EasyPIM [™] 1B	Solder contact	PIM 3-phase input rectifier
FP20R06W1E3_B11	EasyPIM™ 1B	PressFIT	PIM 3-phase input rectifier
FP15R06W1E3	EasyPIM™ 1B	Solder contact	PIM 3-phase input rectifier
FP15R06W1E3_B11	EasyPIM [™] 1B	PressFIT	PIM 3-phase input rectifier
FP10R06W1E3	EasyPIM [™] 1B	Solder contact	PIM 3-phase input rectifier
FP10R06W1E3_B11	EasyPIM™ 1B	PressFIT	PIM 3-phase input rectifier

Selected EasyPACK[™] sixpack portfolio - 600 V

Product	Package	Pin	Description
FS50R06W1E3	EasyPACK [™] 1B	Solder contact	Sixpack
FS50R06W1E3_B11	EasyPACK™ 1B	PressFIT	Sixpack
FS30R06W1E3	EasyPACK™ 1B	Solder contact	Sixpack
FS30R06W1E3_B11	EasyPACK [™] 1B	PressFIT	Sixpack
FS20R06W1E3	EasyPACK™ 1B	Solder contact	Sixpack
FS20R06W1E3_B11	EasyPACK™ 1B	PressFIT	Sixpack





Thermal interface material (TIM)

With the ongoing increase of power densities in power electronics, the thermal interface between power module and heatsink becomes a larger challenge. Infineon's TIM does not only provide the lowest thermal resistance, but it also fulfils the highest quality standards given for power modules to achieve the longest lifetime and highest system reliability. TIM has been developed to fit to most of Infineon's existing power module packages as well as to upcoming future designs. Using modules with TIM applied results in highly reproducible thermal performance of power electronic applications.



5.0 Wireless charging

High efficiency at optimal price/performance ratio for the next level of charging

The limited battery life of mobile devices is driving a revolution in charging solutions. Wireless charging is the leading technology in this revolution, erasing the need for physical connectors and cables to transfer power. Now compatible devices from a wide range of receiver applications can fuel up cable-free using slim and efficient wireless charging transmitters.

Solutions that have high power efficiency, smart heat management, high power density and small footprint are the basis of every design. Infineon offers a variety of innovative components to develop highly reliable and efficient solutions for the transmitter and adapter/charger parts of a wireless charging system. As a member of the Wireless Power Consortium and the AirFuel Alliance, Infineon ensures that its products adhere to the key requirements of the dominant market standards.

Take a look at an overview of cutting-edge solutions from Infineon's comprehensive portfolio of high-quality semiconductors.

Solutions fro		
Various adapters/chargers	Wireless charging pads/sockets	Wireless charging receivers
AC-DC adapters	Transmitters (Tx)	Receivers (Rx)
	Standards are require	d for wireless charging
Qi (inductive) 100 kHz-300 kHz	Inductive AirFuel (PMA) 100 kHz-300 kHz	Resonant AirFuel (A4WP) 6.78 MHz
	AirFuel	Alliance

Key advantages

- BOM reduction due to competitive solution offerings
- > Efficient designs for better transmitter performance
- Enable space saving multi-coil designs-2x2 products
- Faster time to market with IFX adapter/charger solutions
- > Delivery reliability above 90 percent
- > Known quality leader in MOSFETs

Components for inductive (inductive AirFuel and Qi) and low switching frequency transmitter solutions

Infineon offerings for inductive solutions (Qi and inductive Airfuel)



	Voltage	Package	Part number	$R_{DS(on)}$ (max.) @ V_{GS} 4.5 V [m Ω]				
		Current CO0	BSC0996NS	11.8				
	30 V	SuperSO8	BSC0993ND	7.0				
rter			BSZ0589NS	4.4				
Inve		PQFN 3.3 X 3.3	BSZ0994NS	8.6				
		PQFN 2 x 2	IRFHS8342PbF	25				
			IRLHS6342PbF	15.5				
c	20 V		IRLHS6242PbF	11.7 (= 2.5 V drive capable)				
h tioi	25 V		IRFHS8242PbF	21.0				
seled		PQFN 2 X 2	IRFHS8342PbF	25.0				
s lioi s	30 V		IRLHS6342PbF	15.5 (= 2.5 V drive capable)				
0		PQFN 3.3 x 3.3	BSZ0994NS	8.6				
Micro	controller XMC1302 or XMC1404 or XMC4108	XMC1302 or XMC1404 or XMC4108						

Infineon offerings for resonant solutions (Resonant AirFuel)



Class D full-bridge topology shown here, products are suitable for class D half-bridge topology



Class E single-ended topology shown here, products are suitable for class E differential topology

	Voltage	Package	Part number	$R_{_{DS(on)}}$ (max.) @ V _{GS} 4.5 V [mΩ]	Q _g typical	C _{oss} typical	Topology		
	30 V	PQFN Dual 2 x 2	IRLHS6376PbF	48.0	2.8	32	Class D		
		PQFN Dual 3.3 x 3.3	BSZ0909ND	18.5	2.0	~120	Class D		
		SOT 23	IRLML0030PbF	33	2.75	84	Class D		
	40 V	SOT 23	IRLML0040PbF	62	2.8	49	Class D		
er	60 V	SOT 23	IRLML0060PbF	98	2.6	37	Class D		
vert	80 V	PQFN 2 x 2	IRL80HS120	32	3.5	68	Class D/E		
Ē	100 V	PQFN 2 x 2	IRL100HS121	42	2.7	62	Class D/E		
	150 V		BSZ900N15NS3	75*	4.1*	46	Class E		
			BSZ520N15NS3	42*	7.2*	80	Class E		
	200 V		BSZ900N20NS3	78*	7.2*	52	Class E		
		PQFN 3.3 X 3.5	BSZ22DN20NS3	200*	3.5*	24	Class E		
			BSZ12DN20NS3	111*	5.4*	39	Class E		
	250 V		BSZ42DN25NS3	375*	3.6*	21	Class E		
Driver ICs		EiceDRIVER™ 2EDL71**							
		EiceDRIVER™ 1EDN							
Microcontroller		XMC1302 or XMC1404 or XMC4108							

Wireless charging resonant portfolio

* @V_{GS} = 8 V ** Upcoming

Adapter solution

Find the best products for the intended application design. Infineon's broad portfolio, in addition to parts, includes also demo boards and reference designs for switch mode power supplies. All this and more is available from the only supplier to offer a complete range of semiconductor products for your applications.

	Key products used	Summary of features	Benefits
700 V CoolMOS™ P7 40 W flyback adapter design	700 V CoolMOS™ P7, quasi-resonant (QR) flyback controller (ICE2QS03G) and small signal MOSFET	 > Topology: flyback > Input voltage: 90 V_{AC} - 265 V_{AC} > 91.0% efficiency at 230 V_{AC} > 89.5% efficiency at 120 V_{AC} > Low cost single layer design 	 Low cost Higher efficiency
800 V CoolMOS™ P7 45 W flyback adapter design	800 V CoolMOS™ P7, quasi-resonant (QR) flyback controller (ICE2Q503G) and small signal MOSFET	 Topology: flyback Input voltage: 90 V_{AC} - 265 V_{AC} 91.0% efficiency at 230 V_{AC} 89.5% efficiency at 120 V_{AC} Low cost single layer design 	 > Low cost > Higher efficiency



Still not sure which product is the right fit for your design?

Find the right solutions for your wireless charging designs in four steps

Infineon's selection tool for wireless charging designs that allows you to find the right solutions for your designs in just four steps. Select the application, power range, standard and the topology you want to apply and get an overview of Infineon's most recommended offerings for your design.

Wireless charging for consumer - selection tool



For additional information go to: https://www.infineon.com/cms/en/applications/power-supplies/

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- > China, mainland 4001 200 951 (Mandarin/English)
- > India 000 800 4402 951 (English)
- > USA 1-866 951 9519 (English/German)
- > Other countries 00* 800 951 951 951 (English/German)

* Please note: Some countries may require you to dial a code other than "00" to access this international number. Please visit www.infineon.com/service for your country!



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